

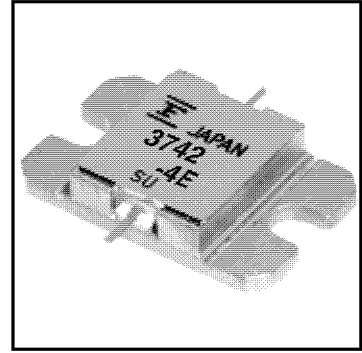
FLM3742-4E

Internally Matched Power GaAs FETs



FEATURES

- High Output Power: $P_{1dB} = 36dBm$ (Typ.)
- High Gain: $G_{1dB} = 12dB$ (Typ.)
- High PAE: $\eta_{add} = 34%$ (Typ.)
- Low $IM_3 = -45dBc@P_o = 25dBm$
- Broad Band: 3.7 ~ 4.2GHz
- Impedance Matched $Z_{in}/Z_{out} = 50\Omega$
- Hermetically Sealed Package



DESCRIPTION

The FLM3742-4E is a power GaAs FET that is internally matched for standard communication bands to provide optimum power and gain in a 50 ohm system.

Fujitsu's stringent Quality Assurance Program assures the highest reliability and consistent performance.

ABSOLUTE MAXIMUM RATING (Ambient Temperature $T_a=25^\circ C$)

Item	Symbol	Condition	Rating	Unit
Drain-Source Voltage	V_{DS}		15	V
Gate-Source Voltage	V_{GS}		-5	V
Total Power Dissipation	P_T	$T_C = 25^\circ C$	25	W
Storage Temperature	T_{stg}		-65 to +175	$^\circ C$
Channel Temperature	T_{ch}		175	$^\circ C$

Fujitsu recommends the following conditions for the reliable operation of GaAs FETs:

1. The drain-source operating voltage (V_{DS}) should not exceed 10 volts.
2. The forward and reverse gate currents should not exceed 8.0 and -2.2 mA respectively with gate resistance of 100 Ω .

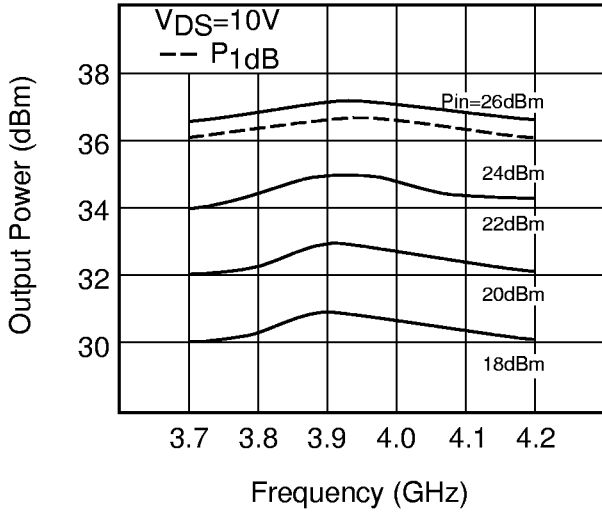
ELECTRICAL CHARACTERISTICS (Ambient Temperature $T_a=25^\circ C$)

Item	Symbol	Test Conditions	Limit			Unit	
			Min.	Typ.	Max.		
Saturated Drain Current	I_{DSS}	$V_{DS} = 5V, V_{GS} = 0V$	-	1800	2700	mA	
Transconductance	g_m	$V_{DS} = 5V, I_{DS} = 1100mA$	-	1000	-	mS	
Pinch-off Voltage	V_p	$V_{DS} = 5V, I_{DS} = 90mA$	-1.0	-2.0	-3.5	V	
Gate Source Breakdown Voltage	V_{GSO}	$I_{GS} = -90\mu A$	-5	-	-	V	
Output Power at 1dB G.C.P.	P_{1dB}	$V_{DS} = 10V,$ $I_{DS} = 0.6 I_{DSS}$ (Typ.), $f = 3.7 \sim 4.2$ GHz, $Z_S = Z_L = 50$ ohm	35	36	-	dBm	
Power Gain at 1dB G.C.P.	G_{1dB}		11	12	-	dB	
Drain Current	I_{dsr}		-	1100	1300	mA	
Power-added Efficiency	η_{add}		-	34	-	%	
Gain Flatness	ΔG		-	-	± 0.6	dB	
3rd Order Intermodulation Distortion	IM_3		$f = 4.2$ GHz, $\Delta f = 10$ MHz 2-Tone Test $P_{out} = 25dBm$ S.C.L.	-42	-45	-	dBc
Thermal Resistance	R_{th}		Channel to Case	-	5	6	$^\circ C/W$

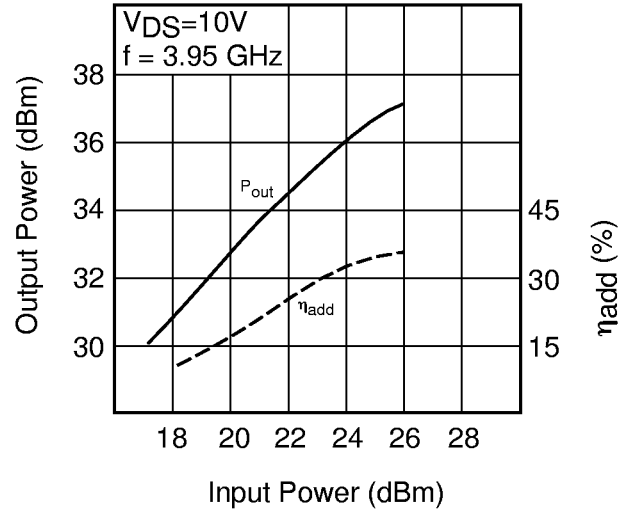
CASE STYLE: IB

G.C.P.: Gain Compression Point, S.C.L.: Single Carrier Level

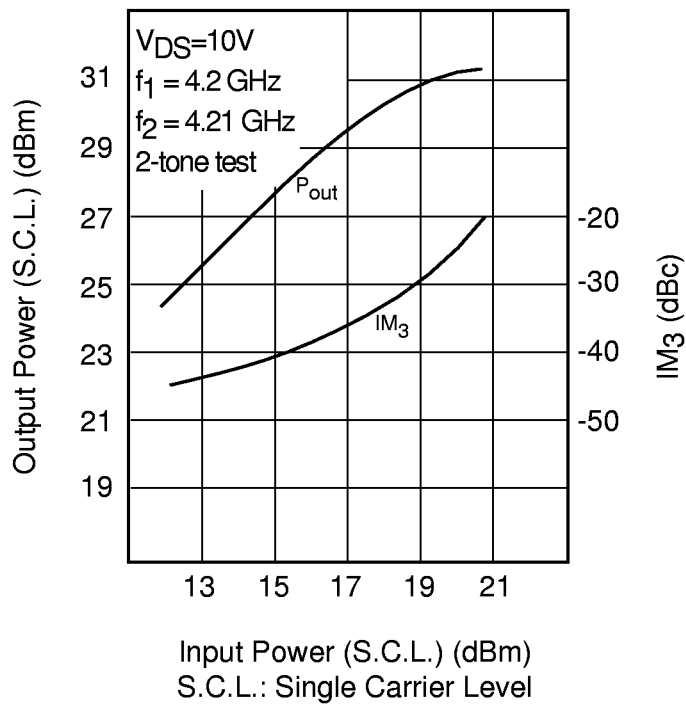
OUTPUT POWER vs. FREQUENCY



OUTPUT POWER vs. INPUT POWER

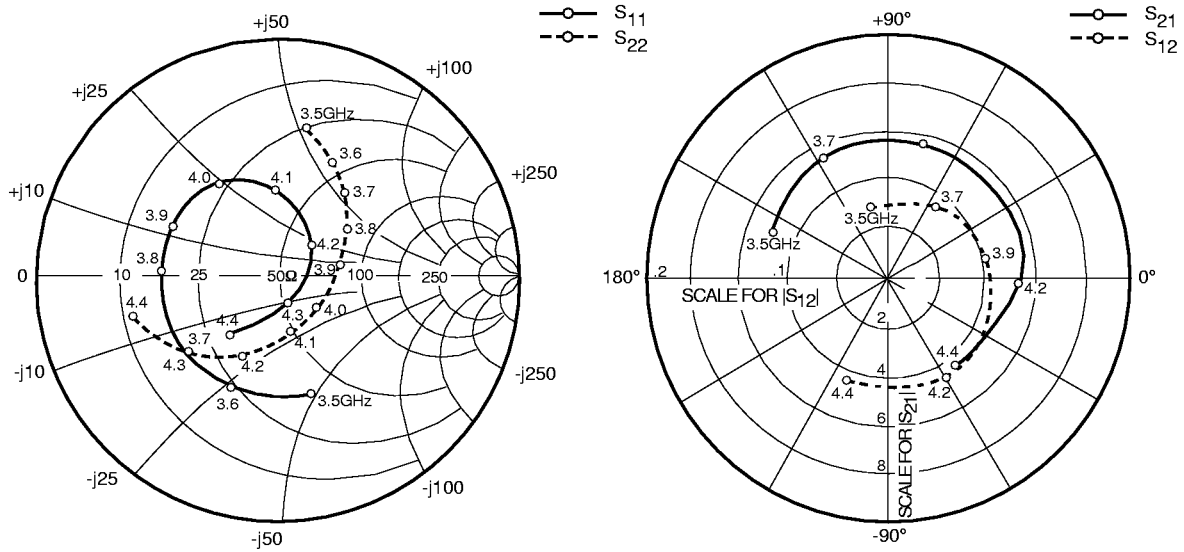


OUTPUT POWER & IM₃ vs. INPUT POWER



FLM3742-4E

Internally Matched Power GaAs FETs



S-PARAMETERS

$V_{DS} = 10V, I_{DS} = 1100mA$

FREQUENCY (MHZ)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
3500	.487	-71.1	4.755	156.7	.059	99.4	.628	76.8
3600	.466	-110.3	5.151	135.8	.067	77.8	.547	64.0
3700	.476	-148.0	5.418	114.3	.074	54.8	.450	50.2
3800	.490	178.5	5.597	92.8	.080	32.3	.355	33.6
3900	.486	148.6	5.705	71.4	.086	10.7	.268	10.3
4000	.442	119.7	5.797	49.3	.091	-10.8	.214	-27.5
4100	.350	88.9	5.813	26.2	.096	-34.1	.241	-74.5
4200	.211	46.9	5.671	1.2	.098	-58.3	.343	-111.4
4300	.121	-48.2	5.304	-24.8	.096	-83.1	.469	-139.9
4400	.266	-126.9	4.694	-50.8	.089	-108.3	.577	-163.0

Case Style "IB"
Metal-Ceramic Hermetic Package

